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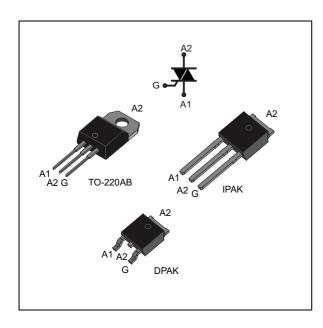






### 4 A Triacs

Datasheet - production data



### **Features**

- Three quadrants Triac
- 600 to 800 V V<sub>DRM</sub>/V<sub>RRM</sub>

### **Applications**

- General purpose AC inductive loads
- Motor control circuits
- Small home appliances

### **Description**

Based on ST's Snubberless / logic level technology providing high commutation performances, the T4 series is suitable for use on AC inductive loads. They are recommended for applications using universal motors, electro valves, kitchen aid equipments, power tools, and dishwashers.

**Table 1. Main characteristics** 

Symbol	Value	Unit	
I <sub>T(rms)</sub>	4	Α	
$V_{DRM}, V_{RRM}$	600 to 800	V	
I <sub>GT</sub>	5 to 35	mA	

Table 2. Device summary

Symbol <sup>(1)</sup>	Marking
T405-xxxB	
T405-xxxB-TR	
T405-xxxH	
T405-xxxT	]
T410-xxxB	
T410-xxxB-TR	see <i>Table 11</i>
T410-xxxH	See Table 11
T410-xxxT	
T435-xxxB	
T435-xxxB-TR	
T435-xxxH	
T435-xxxT	

1. xxx = Voltage: 600 V, 700 V or 800 V (see *Table 10*).

Characteristics T4 series

## 1 Characteristics

Table 3. Absolute maximum ratings ( $T_j = 25$  °C unless otherwise stated)

Symbol	Parame	Parameter					
I <sub>T(rms)</sub>	On-state rms current (full sine wave)	$T_{\rm c} = 110  ^{\circ}$ C		4	Α		
1 -	Non repetitive surge peak on-state	F = 50 Hz	t = 20 ms	30	Α		
I <sub>TSM</sub>	current (full cycle, T <sub>j</sub> initial = 25 °C)	F = 60 Hz	t = 16.7 ms	31	A		
l <sup>2</sup> t	I <sup>2</sup> t value for fusing	t <sub>p</sub> = 10 ms	5.1	A <sup>2</sup> s			
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \le 100 \text{ ns}$	F = 120 Hz	T <sub>j</sub> = 125 °C	50	A/μs		
I <sub>GM</sub>	Peak gate current	t <sub>p</sub> = 20 μs	T <sub>j</sub> = 125 °C	4	Α		
$P_{G(AV)}$	Average gate power dissipation	1	W				
T <sub>stg</sub> T <sub>j</sub>	Storage junction temperature range Operating junction temperature rang	- 40 to +150 - 40 to +125	°C				

Table 4. Electrical characteristics (T $_{j}$  = 25 °C, unless otherwise stated)

Symbol	Test conditions	Quadrant		Value			Unit
Symbol	rest conditions	Quadrant		T405	T410	T435	
I <sub>GT</sub> <sup>(1)</sup>	$V_D = 12 \text{ V}, R_L = 30 \Omega$	1 - 11 - 111	Max.	5	10	35	mA
$V_{GT}$	$V_D = 12 \text{ V}, R_L = 30 \Omega$	1 - 11 - 111	Max.		1.3		٧
$V_{\sf GD}$	$V_D = V_{DRM}, R_L = 3.3 \text{ k} \Omega, T_j = 125 \text{ °C}$	I - II - III	Min.	0.2			V
I <sub>H</sub> <sup>(2)</sup>	I <sub>T</sub> = 100 mA		Max.	10	15	35	mA
	I <sub>G</sub> = 1.2 I <sub>GT</sub>	1 - 111	Max.	10	25	50	mA
IL	IG = 1.2 IGT	II	Max.	15	30	60	ША
dV/dt (2)	$V_D = 67\% V_{DRM}$ , gate open	T <sub>j</sub> = 125 °C	Min.	20	40	400	V/µs
	$(dV/dt)c = 0.1 V/\mu s$			1.8	2.7		
(dl/dt)c (2)	$(dV/dt)c = 10 V/\mu s$	T <sub>j</sub> = 125 °C	Min.	0.9	2.0		A/ms
	(without snubber)					2.5	

<sup>1.</sup> Minimum  $I_{GT}$  is guaranteed at 5% of  $I_{GT}$  max.

<sup>2.</sup> For both polarities of A2 referenced to A1

T4 series Characteristics

**Table 5. Static characteristics** 

Symbol	Test c	Value	Unit		
V <sub>TM</sub> <sup>(1)</sup>	$I_{TM} = 5.5 \text{ A}, t_p = 380 \ \mu \text{s}$	T <sub>j</sub> = 25 °C	Max.	1.56	V
V <sub>t0</sub> <sup>(1)</sup>	Threshold voltage	T <sub>j</sub> = 125 °C	Max.	0.89	V
R <sub>d</sub> <sup>(1)</sup>	Dynamic resistance	T <sub>j</sub> = 125 °C	Max.	120	mΩ
I <sub>DRM</sub>	V – V	T <sub>j</sub> = 25 °C	Max.	5	μΑ
$I_{RRM}$	$V_{DRM} = V_{RRM}$	T <sub>j</sub> = 125 °C	iviax.	1	mA

<sup>1.</sup> For both polarities of A2 referenced to A1

Table 6. Thermal resistance

Symbol		Value	Unit		
R <sub>th(j-c)</sub>	Junction to case (AC)		IPAK, DPAK,TO-220AB	2.6	°C/W
	Junction to ambient	$S^{(1)} = 0.5 \text{ cm}^2$	DPAK	70	°C/W
R <sub>th(j-a)</sub>	Junction to ambient		TO-220AB	60	°C/W
			IPAK	100	°C/W

<sup>1.</sup> S = Copper surface under tab.

Characteristics T4 series

Figure 1. Maximum power dissipation versus RMS on-state current (full cycle)

P(W)

IT(RMS)(A)

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Figure 2. RMS on-state current versus case temperature (full cycle)  $I_{T(RMS)}(A)$ 4.0 TO-220AB / DPAK / IPAK 3.5 3.0 2.5 2.0 1.5 1.0 0.5 T<sub>C</sub>(°C) 0.0 0 25 50 75 100

temperature (printed circuit board FR4, copper thickness: 35µm) (full cycle)

50

7 5

Figure 3. RMS on-state current versus ambient

Figure 4. Relative variation of thermal impedance versus pulse duration

1E+0

K = [Zth / Rth]

TO-220AB / DPAK / IPAK

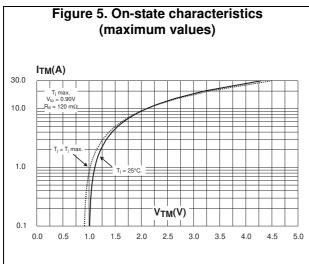
1E-1

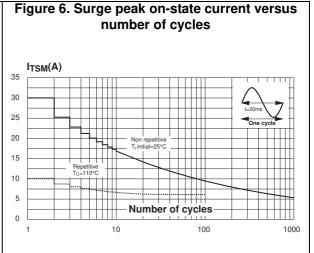
DPAK / IPAK

1E-2

1E-2

1E-1





0.4

0.0

0

25

125

100

T4 series Characteristics

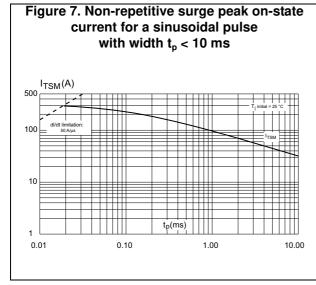


Figure 8. Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)

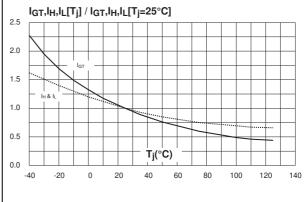


Figure 9. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)

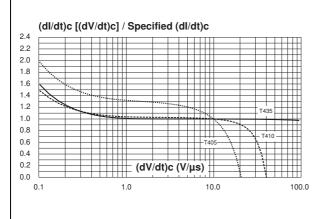


Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature

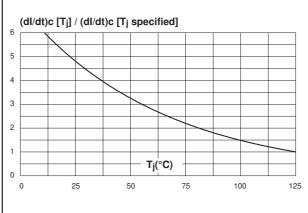
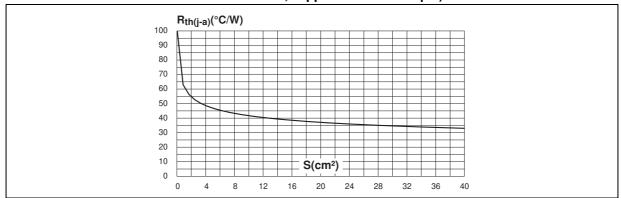


Figure 11. DPAK thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: 35 μm)



**Package information** T4 series

#### 2 **Package information**

- Molding epoxy meets UL94, V0 and is halogen free
- Lead-free package
- Recommended torque: 0.4 to 0.6 N·m for TO-220AB

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK<sup>®</sup> is an ST trademark.

#### 2.1 **DPAK** package information

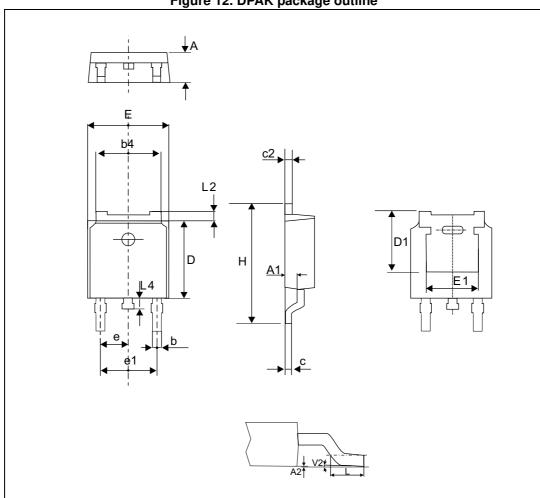


Figure 12. DPAK package outline

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

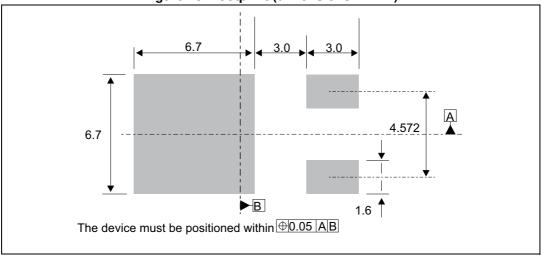
T4 series Package information

Table 7. DPAK package mechanical data

				nsions		
Ref.		Millimeters			Inches <sup>(1)</sup>	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.18		2.40	0.086		0.0944
A1	0.9		1.10	0.035		0.0433
A2	0.03		0.23	0.0011		0.0090
b	0.64		0.90	0.0251		0.0354
b4	4.95		5.46	0.1948		0.2149
С	0.46		0.61	0.0181		0.0240
c2	0.46		0.60	0.0181		0.0236
D	5.97		6.22	0.2350		0.2448
D1	4.95			0.1948		
E	6.35		6.73	0.2500		0.2649
E1	4.32			0.1700		
е		2.286			0.09	
e1		4.572			0.18	
Н	9.35		10.40	0.3681		0.4094
L	1.0		1.78	0.039		0.0700
L2			1.27			0.0500
L4	0.6		1.02	0.023		0.0401
V2	-8°		+8°	-8°		+8°

<sup>1.</sup> Inch dimensions are only for reference

Figure 13. Footprint (dimensions in mm)



Package information T4 series

## 2.2 IPAK package information

 $\begin{bmatrix} E \\ b4 \\ \end{bmatrix}$   $\begin{bmatrix} C2 \\ V_1 \\ \end{bmatrix}$   $\begin{bmatrix} D \\ \end{bmatrix}$   $\begin{bmatrix}$ 

Figure 14. IPAK package outline

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 8. IPAK package mechanical data

			Dime	nsions		
Ref.		Millimeters			Inches <sup>(1)</sup>	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.20		2.40	0.0866		0.0945
A1	0.90		1.10	0.0354		0.0433
b	0.64		0.90	0.0252		0.0354
b2			0.95			0.0374
b4	5.20		5.43	0.2047		0.2138
С	0.45		0.60	0.0177		0.0236
c2	0.46		0.60	0.0181		0.0236
D	6		6.20	0.2362		0.2441
E	6.40		6.65	0.2520		0.2618
е		2.28			0.0898	
e1	4.40		4.60	0.1732		0.1811
Н		16.10			0.6339	
L	9		9.60	0.3543		0.3780
L1	0.8		1.20	0.0315		0.0472
L2		0.80	1.25		0.0315	0.0492
V1	_	10°	_		10°	

<sup>1.</sup> Inch dimensions are only for reference

Package information T4 series

## 2.3 TO-220AB (insulated and non-insulated) information

В С ØΙ b2 ↑ L F Α 14 13 c2 a1 12 a2 M с1 b1

Figure 15. TO-220AB (insulated and non-insulated) package outline

T4 series Package information

Table 9. TO-220AB (insulated and non-insulated) package mechanical data

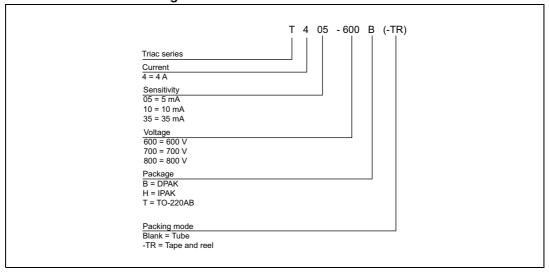
	Dimensions									
Ref.		Millimeters			Inches <sup>(1)</sup>					
	Min.	Тур.	Max.	Min.	Тур.	Max.				
Α	15.20		15.90	0.5984		0.6259				
a1		3.75			0.1476					
a2	13.00		14.00	0.5118		0.5511				
В	10.00		10.40	0.3937		0.4094				
b1	0.61		0.88	0.0240		0.0346				
b2	1.23		1.32	0.0484		0.0519				
С	4.40		4.60	0.1732		0.1811				
c1	0.49		0.70	0.0192		0.0275				
c2	2.40		2.72	0.0944		0.1070				
е	2.40		2.70	0.0944		0.1062				
F	6.20		6.60	0.2440		0.2598				
ØI	3.73		3.88	0.1468		0.1527				
14	15.80	16.40	16.80	0.6220	0.6456	0.6614				
L	2.65		2.95	0.1043		0.1161				
12	1.14		1.70	0.0448		0.0669				
13	1.14		1.70	0.0448		0.0669				
М		2.60			0.1023					

<sup>1.</sup> Inch dimensions are only for reference

Ordering information T4 series

# 3 Ordering information

Figure 16. Order information scheme



**Table 10. Product selector** 

Doub would be	Voltage (xxx)			Completivites	T	Dealesse
Part number	600 V	700 V	800 V	Sensitivity	Туре	Package
T405-xxxB	Х			5 mA	Logic level	DPAK
T405-xxxB-TR	Х	Х	Х	5 mA	Logic level	DPAK
T405-xxxH	Х		Х	5 mA	Logic level	IPAK
T405-xxxT	Х			5 mA	Logic level	TO-220AB
T410-xxxB	Х			10 mA	Logic level	DPAK
T410-xxxB-TR	Х		Х	10 mA	Logic level	DPAK
T410-xxxH	Х		Х	10 mA	Logic level	IPAK
T410-xxxT	Х	Х	Х	10 mA	Logic level	TO-220AB
T435-xxxB	Х			35 mA	Snubberless	DPAK
T435-xxxB-TR	Х	Х	Х	35 mA	Snubberless	DPAK
T435-xxxH	Х		Х	35 mA	Snubberless	IPAK
T435-xxxT	Х		Х	35 mA	Snubberless	TO-220AB

Blank = Unavailable

**Table 11. Ordering information** 

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T405-600B	T4 0560				
T410-600B	T4 1060			75	Tube
T435-600B	T4 3560				
T405-600B-TR	T4 0560				
T410-600B-TR	T4 1060				
T435-600B-TR	T4 3560	DPAK	0.3 g		
T405-700B-TR	T4 0570			2500	Tape and reel
T435-700B-TR	T4 3570			2300	Tape and reer
T405-800B-TR	T4 0580				
T410-800B-TR	T4 1080				
T435-800B-TR	T4 3580				
T405-600H	T4 0560				
T410-600H	T4 1060				
T435-600H	T4 3560	IPAK	0.4 g	75	
T405-800H	T4 0580	IFAR	0.4 g	75	
T410-800H	T4 1080				
T435-800H	T4 3580				Tube
T405-600T	T405-600T				Tube
T410-600T	T410-600T				
T435-600T	T435-600T	TO-220AB	2.3 g	50	
T410-700T	T410-700T	10-220AB	2.3 y	50	
T410-800T	T410-800T				
T435-800T	T435-800T				

Revision history T4 series

# 4 Revision history

**Table 12. Document revision history** 

Date	Revision	Changes
Jun-2003	2	Last updated.
25-Mar-2005	3	Layout updated, No content change.
25-Jan-2006	4	Markings changed in Table 12.
14-May-2014	5	Updated DPAK and IPAK package information and reformatted to current standard.
11-Feb-2015	6	Updated package silhouettes in cover page.
1-Apr-2016	7	Removed ISOWATT-220AB package information.
05-Oct-2016	8	Updated Table 3 and Table 11. Updated Figure 2 and Figure 4.
14-Nov-2016	9	Updated Table 1.

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